TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSVI-H)

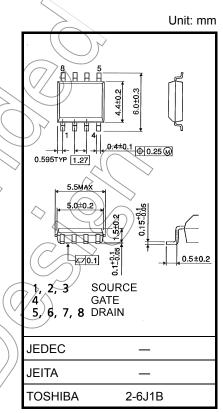
TPC8035-H

High Efficiency DC-DC Converter Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- High-speed switching
- Small gate charge: Q_{SW} = 17 nC (typ.)
- Low drain-source ON-resistance: $RDS(ON) = 2.3 m\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 70 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement mode: $V_{th} = 1.3$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

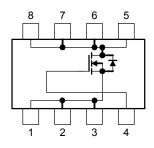
Absolute Maximum Ratings (Ta = 25°C)

			()	\sim	
Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	30	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR (}	30	V	
Gate-source voltage		V _{GSS}	±20	< <v< td=""></v<>	
Drain current	DC (Note 1)	ID	18	A	
	Pulsed (Note 1)	LDP	72	~ ~ `	
Drain power dissipation (t = 10 s)			1.9 ~	w	
(Note 2a)		FD	1.9		
Drain power dissipation $(t = 10 s)$ (Note 2b)		PD	1.0	w	
Single pulse avalanche energy (Note 3)		Eas	211	mJ	
Avalanche current		IAR	18	А	
Repetitive avalarche energy		EAR	0.082	mJ	
Channel temperature		(Tich	150	°C	
Storage temperature range		Tstg	–55 to 150	°C	



Weight: 0.085 g (typ.)

Circuit Configuration



Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating" Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

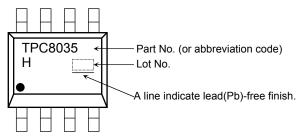
This transistor is an electrostatic-sensitive device. Handle with care.

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Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	65.8	°C/W
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	125	°C/W

Marking (Note 5)



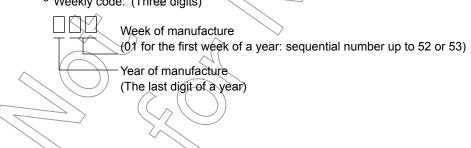
Note 1: Ensure that the channel temperature does not exceed 150°C

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



- Note 3: $V_{DD} = 24 \text{ V}, T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 500 \text{ }\mu\text{H}, R_{G} = 25 \Omega, I_{AR} = 18 \text{ A}$
- Note 4: Repetitive rating: pulse width limited by max channel temperature
- Note 5: on lower left of the marking indicates Pin 1.
 - * Weekly code: (Three digits)



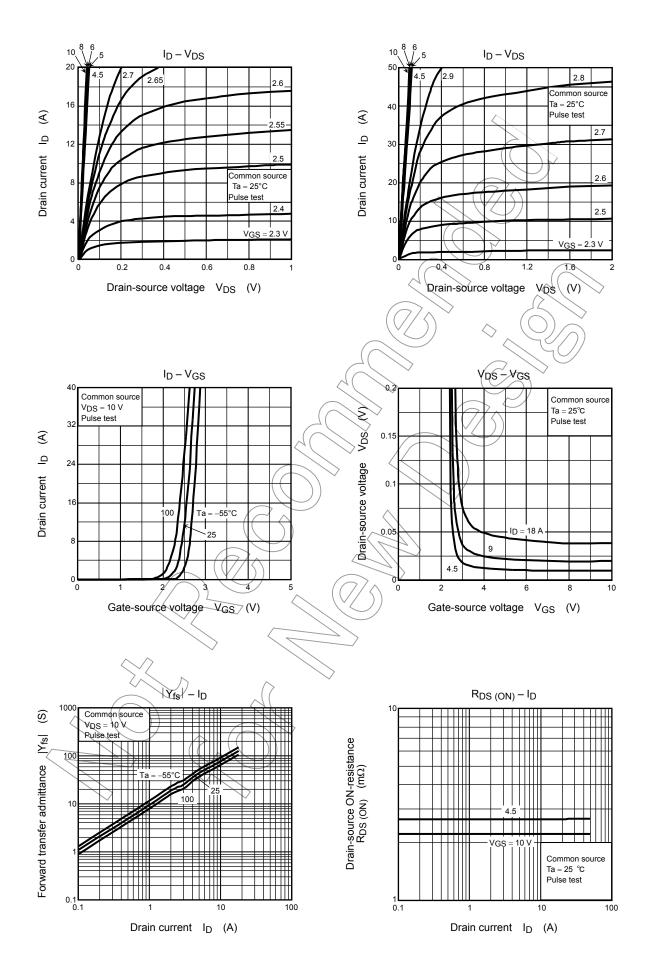
Electrical Characteristics (Ta = 25°C)

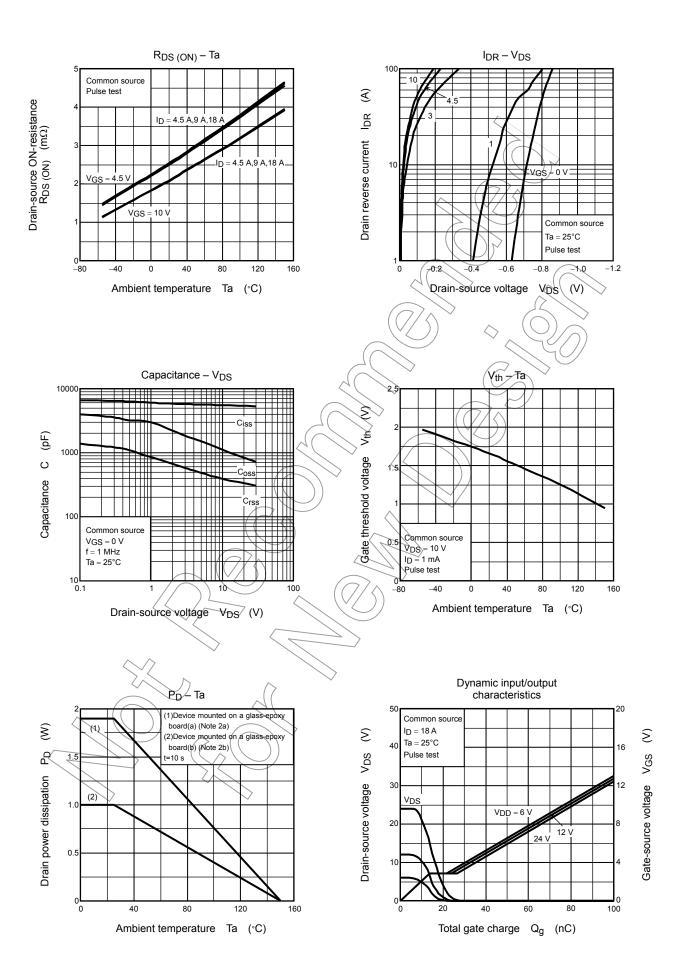
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 20~V,~V_{DS}=0~V$	_	_	±100	nA
Drain cut-OFF cu	rrent	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	—	_	v
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15		_	v
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	13	-7(2.3	V
Drain-source ON-resistance		R _{DS (ON)}	$V_{GS} = 4.5 \text{ V}, I_D = 9 \text{ A}$		2.6	3.6	mΩ
			$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$	\mathcal{A}	2.3	3.2	1115.2
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 9 A	35	70	_	S
Input capacitance		C _{iss}			6000	7800	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		380	610	pF
Output capacitance		C _{oss}			(1100	\searrow	
Gate resistance		rg	V _{DS} = 10 V, V _{GS} ≠ 0 V, f ≠ 1 MHz	-6	1.0	> 1.5	Ω
Switching time	Rise time	tr		K C	5.1) _	
	Turn-ON time	t _{on}	$V_{GS} = 9 A$		> <u>)</u> 16		20
	Fall time	t _f			11	ns	115
	Turn-OFF time	toff	$V_{DD} \approx 15$ V Duty $\leq 1\%$, t _w $\neq 10$ µs	_	69	—	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \approx 24 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 18 \text{ A}$		82	_	
			$V_{DD} \approx 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 18 \text{ A}$		44	_	
Gate-source char	rge 1	Qĝs1		_	14	_	nC
Gate-drain ("miller") charge		Qgd	$V_{DD} \approx 24 V, V_{GS} = 10 V, I_D = 18 A$		13	_	
Gate switch charge		QSW		_	17	_	

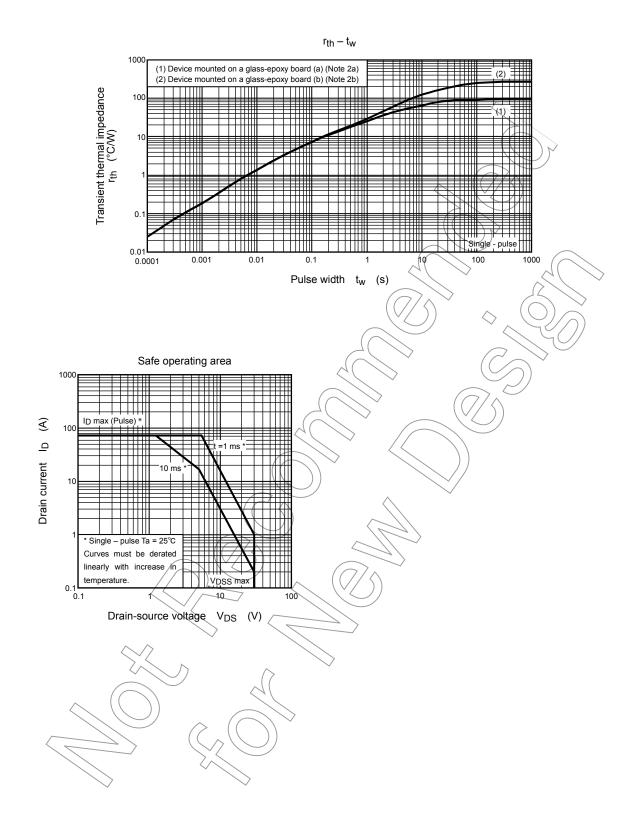
Source-Drain Ratings and Characteristics (Ta \pm 25°C)

Characteristics	Symbol Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note 1)	IDRP —	_	_	72	А
Forward voltage (diøde)	V_{DSF} $I_{\text{DR}} = 18 \text{ A}, V_{\text{GS}} = 0 \text{ V}$	—		-1.2	V

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